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# **Supporting Information:**

# Engineering the Palladium–WSe<sub>2</sub> Interface Chemistry for Field Effect Transistors with High Performance Hole Contacts

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#### 1. van der Waals Pd–WSe<sub>2</sub> Interface at Room Temperature: XPS Results

When deposited at room temperature (RT), reaction products are not detected at the Pd– WSe<sub>2</sub> interface regardless of chamber pressure. The chemical states detected in the corresponding Se 3*d*, W 4*f*, and Pd 3*d* core level spectra reflect bulk WSe<sub>2</sub> and metallic Pd, respectively (Figure S1a). The WSe<sub>2</sub> chemical states in the W 4*f* and Se 3*d* core level spectra shift to lower binding energy (BE) after Pd deposition under either UHV or HV conditions indicating the  $E_F$  shifts towards the valence band edge. This is consistent with upward band bending in WSe<sub>2</sub> due to the high  $\Phi$  of Pd relative to the  $E_F$  of WSe<sub>2</sub>.

The two spin orbit split branches of the Pd 3d core level spectrum detected following Pd deposition on WSe<sub>2</sub> in UHV exhibit larger full widths at half maximum (FWHM) than that of the metal Pd 3d reference spectrum (Figure S1b). However, the BE of the Pd  $3d_{5/2}$  core level obtained following deposition under UHV and HV conditions (Pd<sup>0</sup>: 334.96 eV) agrees well with that of the Pd reference film obtained in this work (334.93 eV). Furthermore, Pd 3d core level peak shapes similar to those obtained after Pd deposition at RT in this work have been observed previously in photoemission studies of Pd films on MoS<sub>2</sub><sup>1</sup> and isolated Pd clusters on various substrates.<sup>2</sup> It is also noted that any oxygen based species present on the 'initial' exfoliated WSe<sub>2</sub> samples employed in this work are below the limit of XPS detection (Figure S1c). The Pd  $3p_{3/2}$  and O 1s core levels, when carefully deconvolved, indicates that oxygen is below the limit of detection after Pd deposition in UHV (Figure S1c). This deconvolution/fitting procedure is discussed in greater detail later in this section. Both the reference metal Pd film and the Pd deposited on WSe<sub>2</sub> in UHV exhibit asymmetric line shapes consistent with core hole screening in metallic species.<sup>3</sup> However, the two spin orbit split peaks in the 'UHV' Pd 3d spectrum are slightly more asymmetric than that of the reference Pd film, which is assumed to be an inherent feature of the Pd islands comprising

the film deposited on WSe<sub>2</sub> and not due to Pd–O formation. Therefore, only metallic Pd is detected when Pd is deposited on WSe<sub>2</sub> at RT in UHV in contrast to the pronounced Pd–C chemical state detected in the Pd 3d core level spectrum from the Pd–graphite interface.<sup>4</sup>



**Figure S1:** a) Se 3*d*, W 4*f*, b) Pd 3*d*, c) O 1*s* and d) C 1*s* core level spectra obtained by XPS from exfoliated WSe<sub>2</sub> (Initial) and following Pd deposition under UHV and HV conditions.

Oxygen is below the limit of XPS detection on exfoliated WSe<sub>2</sub>. The broad peak detected in the same region as the O 1*s* core level after Pd deposition in UHV corresponds with the Pd  $3p_{3/2}$ core level. The Pd  $3p_{3/2}$  and O 1*s* core levels are deconvolved by applying fitting parameters obtained from the reference Pd  $3p_{3/2}$  and Pd  $3d_{5/2}$  core level spectra (Pd  $3p_{3/2}$  full width at half maximum and double lorentzian factor = 2.85 eV and 1.6, respectively; separation between Pd  $3p_{3/2}$  and Pd  $3d_{5/2}$  core levels = 197.00 eV). Any additional chemical states necessary to obtain an accurate fit ( $\chi^2 \le 0.001$ ) of the raw data are attributed to the O 1*s* core level. Applying the reference fit parameters to the peak in the 'UHV' spectrum in Figure S1a yields an accurate fit of the raw data, which indicates oxygen is below the limit of XPS detection (<0.1 at. %) after Pd deposition in UHV. When deconvoluting the 'HV' spectrum in Figure S1a, two chemical states with 0.72 eV separation and 0.34 area ratio (Pd–O:Pd–Pd ratio, obtained from the two chemical states fit to the corresponding Pd 3*d* spectrum) are employed to fit the Pd 3*p*<sub>3/2</sub> contribution to the overall spectrum. An additional peak is included to obtain an accurate fit of the raw data, which is assigned to the O–Pd chemical state in the O 1*s* core level.

The spectra shown in Figure S1b are convoluted by the C 1*s* core level (narrow peak) and a broad Se LMM Auger peak. A chemical state corresponding with adventitious carbon is detected in the C 1*s* spectrum obtained from exfoliated WSe<sub>2</sub> (~284.6 eV) and shifts ~0.4 eV to lower binding energy (BE) after Pd is deposited (independent of deposition chamber base pressure). The bulk WSe<sub>2</sub> chemical states in the W 4*f* and Se 3*d* core levels also shift ~0.4 eV to lower binding energy, which indicates band bending induced in the WSe<sub>2</sub> by the deposited Pd also manifests as a E<sub>F</sub> shift in the adventitious carbon. The chemical state in the C 1*s* core level associated with C– Pd bonds at Pd/graphene and Pd/graphite interfaces is detected at 284.0 eV,<sup>4</sup> which is more than 0.2 eV lower than the BE of the C 1*s* chemical state detected in this work after Pd deposition on WSe<sub>2</sub> substantiating our argument that Pd does not react with adventitious carbon on WSe<sub>2</sub>.

## 2. Stoichiometry Calculation Method

The stoichiometry of bulk WSe<sub>2</sub> and any other reaction products referred to in the main text were calculated using appropriate relative sensitivity factors for the W 4*f*, Se 3*d*, and Pd 3*d* 

core levels (2.959, 0.722, and 4.642, respectively, with all three reflecting both spin orbit split peaks in each of the aforementioned core levels).<sup>5</sup> These relative sensitivity factors apply to the particular XPS instrument employed in this study. Dividing the integrated intensity of core level spectra corresponding with the elements in a compound by these sensitivity factors permits estimation of stoichiometry and overall elemental concentration. Stoichiometry ratios calculated employing the above described method are accompanied by a  $\pm 0.2$  error. For instance, intrinsic WSe<sub>2</sub> would exhibit a Se:W ratio of 2:1 $\pm 0.2$ .



**Figure S2.** a) Se 3*d*, W 4*f*, b) valence band, c) O 1*s*, and d) C 1*s* core level spectra obtained throughout annealing bulk WSe<sub>2</sub> under UHV or FG conditions. Colors represent the anneal temperature.

The family of transition metal dichalcogenides materials are prone to defect formation (*i.e.* chalcogen vacancies) at elevated temperatures,<sup>6,7</sup> with increasing instability as the chalcogen atomic mass increases. Reactions between metal and TMD are likely far more favorable at defect sites within the vicinity of the TMD surface than across a defect–free van der Waals plane. Therefore, it is possible that annealing under UHV or FG conditions decomposes WSe<sub>2</sub> thereby facilitating reactions with Pd. Separate bulk WSe<sub>2</sub> samples were consecutively annealed at 200 °C, 300 °C, 400 °C, and 450 °C for one hour each under UHV or FG conditions obtaining XPS *in–situ* 

after each annealing step to investigate its thermal stability at annealing temperatures employed in this work (Figure S2).

Both exfoliated WSe<sub>2</sub> samples exhibit sharp, symmetric doublets in the Se 3*d* and W 4*f* core level spectra consistent with a lack of  $E_F$  variation across either XPS sampling area (Figure S2a). The FWHM and binding energies of the bulk WSe<sub>2</sub> chemical states and also the valence band edge (Figure S2b) remain constant at all annealing temperatures and ambients, which indicates chemical stability. A small concentration of oxygen is detected on the sample annealed in UHV (Figure S2c), which likely corresponds with WO<sub>x</sub> according to the BE at ~530.2 eV consistent with a transition metal oxide. However, this does not cause a discrepancy in the  $E_F$  between the two samples as the valence band edges detected from each sample throughout annealing align quite closely. Adventitious carbon is detected on both exfoliated WSe<sub>2</sub> samples, which is consistent with all bulk WSe<sub>2</sub> samples employed throughout this work (Figure S2d). The concentration of carbon decreases slightly while annealing at 200 °C and is completely desorbed while annealing at 300 °C regardless of annealing ambient. In addition, the Se:W ratio remains constant throughout annealing (Table S1). This provides strong evidence that bulk WSe<sub>2</sub> employed here is chemically stable throughout the thermal budget imparted during the annealing experiments. **Table S1:** Se:W ratio calculated from core level spectra obtained from exfoliated, bulk WSe<sub>2</sub> prior to and throughout *in–situ* annealing under UHV ( $<2 \times 10^{-9}$  mbar) and forming gas (90% N<sub>2</sub>, 10% H<sub>2</sub>; 1 mbar) conditions.

	Stoichiometry (Se:W)		
	UHV	FG	
Exfoliated	2.01	1.99	
200°C	2.01	2.07	
300°C	1.99	2.06	
400°C	2.00	2.04	
450°C	2.00	2.01	

4. Pd–WSe2: Chemical State Evolution Throughout Stepwise Pd Deposition and Post Metallization

Annealing under UHV Conditions



**Figure S3:** Deconvoluted Se 3*d*, W 4*f*, and W 5 $p_{3/2}$  core level spectra obtained throughout Pd deposition on WSe<sub>2</sub> and post metallization annealing in UHV. The inset plots at right and left display magnified Se 3*d* and W 4*f* core level spectra obtained following each anneal. Residuals associated with the peak fits are 0.001 % (not shown for clarity).

Figure S3 displays the evolution of the Se 3*d* and W 4*f* core level spectra throughout stepwise Pd deposition and post metallization annealing under UHV conditions. The chemical states in the Se 3*d* and W 4*f* core levels are initially detected from exfoliated WSe<sub>2</sub> at binding energies of 55.05 and 32.80 eV, respectively, and remain the only detectable chemical states throughout Pd deposition. Expanded Se 3*d* and W 4*f* core level spectra obtained following each anneal are displayed adjacent to Figure S3 accentuating minute changes with increased annealing temperature. The formation of PdSe<sub>x</sub> after annealing at 300 °C is evidenced by the additional state appearing at low BE (54.42 eV) in the corresponding Se 3*d* core level. Concomitant formation of WSe<sub>x</sub> is evidenced by the high BE state (55.11 eV) in the Se 3*d* core level and corresponding low BE state in the W 4*f* core level (31.99 eV). No W–W bonding is detected at 31.20 eV in the W 4*f* core level spectrum throughout the experiment. PdSe<sub>x</sub> exhibits a Se<sup>2-</sup> chemical state with lower BE than that of bulk WSe<sub>2</sub> due to the greater electronegativity difference between Pd and Se (0.35) compared with that between W and Se (0.19).<sup>8</sup> This results in a greater ionic character associated with the Pd–Se bond compared with the W–Se bond in WSe<sub>2</sub>.

The chemical states associated with WSe<sub>x</sub> shift by +0.29 eV and -0.15 eV in the Se 3*d* and W 4*f* core level spectra, respectively, following the 400 °C UHV anneal. This suggests further WSe<sub>x</sub> reduction with increased annealing temperature as the binding energies of the associated chemical states shift towards the expected binding energies of elemental Se (55.50 eV) and W (31.20 eV), respectively.

In addition, WO<sub>x</sub> is detected in the W 4*f* core level after annealing at 400 °C as evidenced by the appearance of a high BE state at 35.69 eV. The Pd film undergoes mild agglomeration at 400 °C, possibly leaving regions of extremely thin Pd or even exposed WSe<sub>x</sub> or WSe<sub>2</sub>. WO<sub>x</sub> formation could occur in these regions from reactions with background gases in the chamber considering the pressure increases to  $\sim 10^{-7}$  mbar during the first 10 minutes of the anneal, then decreases quickly into UHV. The normalized O 1*s* core level spectra obtained after RT Pd deposition and *in–situ* annealing under UHV conditions are shown in Figure S4. The Pd  $3p_{3/2}$  core level convolutes the O 1*s* core level spectrum. There are no resolvable peaks below 531.0 eV that would suggest the formation of Pd–O or W–O bonds throughout the experiment. However, the intensity of the WO<sub>x</sub> chemical state in the W 4*f* core level spectrum obtained after 400 °C UHV anneal (Figure S3) suggests the intensity of the associated oxygen chemical state should be comparable with the noise detected in the corresponding O 1*s* core level spectrum.



**Figure S4:** O 1*s* core level spectra convoluted by the Pd  $3p_{3/2}$  core level spectra obtained after ~5 nm Pd deposition on WSe<sub>2</sub> and post metallization annealing in UHV.

5. Pd–WSe<sub>2</sub>: Chemical State Evolution Throughout Post Metallization Annealing under FG Conditions



**Figure S5:** Deconvoluted Se 3*d*, W 4*f*, and W 5 $p_{3/2}$  core level spectra obtained after annealing a ~50 Å Pd–WSe<sub>2</sub> structure in forming gas (1 mbar) for 1 hr at 200 °C, 300 °C, and 400 °C, respectively.

Pd reduces WSe<sub>2</sub> and forms substoichiometric WSe<sub>x</sub> during the 200 °C FG anneal as shown by the appearance of chemical states at 55.27 and 31.99 eV in the corresponding Se 3*d* and W 4*f* core level spectra (Figure S5) in addition to those of the bulk WSe<sub>2</sub>. Concomitant PdSe<sub>x</sub> formation is detected at 53.86 eV in the corresponding Se 3*d* core level spectrum. However, the WSe<sub>x</sub> chemical state in the W 4*f* (Se 3*d*) core level shifts -0.19 eV (-0.13 eV) towards elemental W (away from elemental Se) after the 400 °C FG anneal consistent with a decreased (increased) oxidation state. Considering the Pauling electronegativities of Pd (2.20) and W (2.36),<sup>8</sup> the BE shifts exhibited by the WSe<sub>2</sub> chemical states after 400 °C FG anneal suggest W–Se–Pd bonds form as an intermediate step to PdSe<sub>x</sub> formation.

Any WO<sub>x</sub> that forms while annealing in FG remains below the limit of detection. Metallic W also remains below the limit of XPS detection throughout FG anneals.

	kJ/mol	kcal/mol	eV
H-H <sup>9</sup>	432.1	103.27	4.48
W-Se <sup>10</sup>	418.1	99.92	4.33
H-Se <sup>11</sup>	310.7	74.26	3.22
H-(SeH) <sup>11</sup>	330.1	78.89	3.42
H-(Se⁺) <sup>9</sup>	306.0	73.14	3.17
H-(Se <sup>-</sup> ) <sup>9</sup>	331.0	79.11	3.43
H-Pd(diatomic) <sup>9</sup>	234.0±25.0	55.93±5.98	2.43±0.26
H- Pd(polycrystalline) <sup>9</sup>	59	14.10	0.61
H-Pd(111) <sup>9</sup>	253.0	60.47	2.62
H <sub>2</sub> -Pd(111) <sup>9</sup>	87.0	20.79	0.90
Pd-Pd <sup>9</sup>	136.0	32.50	1.41
H-(W⁺) <sup>9</sup>	222.5	53.18	2.31
H-W(100) <sup>9</sup>	283.0	67.64	2.93
H-W(110) <sup>9</sup>	285.0	68.12	2.95
H-W(111) <sup>9</sup>	294.0	70.27	3.05
H-W(211) <sup>9</sup>	289.0	69.07	3.00
H <sub>2</sub> - W(polycrystalline) <sup>9</sup>	134.0	32.03	1.39
H <sub>2</sub> -W(100) <sup>9</sup>	156.0	37.28	1.62
H <sub>2</sub> -W(110) <sup>9</sup>	136.8	32.70	1.42
H <sub>2</sub> -W(111) <sup>9</sup>	153.0	36.57	1.59
H <sub>2</sub> -W(211) <sup>9</sup>	146.0	34.89	1.51
Pd-Se		Not known	

Table S2: Bond dissociation energies of relevant bonds in the Pd–WSe<sub>2</sub> system in the presence of FG.

In the main text, some of the bond dissociation energies listed above and related Gibbs free energies of formation are employed to formulate the reaction mechanism that validates the onset of PdSe<sub>x</sub> formation at lower annealing temperature and  $\sim 3 \times$  greater PdSe<sub>x</sub> concentration after 400 °C anneal when annealing is performed in FG compared with UHV.

#### 7. Raman Laser–Induced Damage in WSe<sub>2</sub> Flakes and Optimizing Parameters to Prevent Damage

Laser induced damage has been observed previously in MoS<sub>2</sub> due to Joule heating when great enough power density, exposure time, and/or a large enough number of spectral accumulations are employed.<sup>12</sup> It is therefore reasonable to expect a similar or even greater potential for laser induced damage in other TMDs with equal or lesser chemical stability compared to MoS<sub>2</sub>, such as WSe<sub>2</sub>.<sup>13</sup> Laser induced interface perturbation could result in erroneous conclusions regarding the number of WSe<sub>2</sub> layers consumed in reactions with an overlying contact metal. Therefore, determining parameters that 1) maximize spectral intensity after metal deposition and Si capping and 2) do not damage the underlying WSe<sub>2</sub> (excluding spectral changes associated with reactions that occur during deposition or post metallization annealing) is critical for accurate interpretation of associated Raman spectra. Pd–Si bonds are Raman active (vibrational modes appearing between 90 and 200 cm<sup>-1</sup>)<sup>14</sup> but expected features are below the limit of detection in all Raman spectra obtained from Si capped Pd–WSe<sub>2</sub> samples investigated in this work.

Various combinations of laser power density (0.49 and 3.32 mW/µm<sup>2</sup>), exposure time (1, 2, 3, 4, 5, and 10 s), and number of spectral accumulations (5, 10, and 20) were tested on the exfoliated WSe<sub>2</sub> surface. The surface topography and spatial variation in composition (phase) of exfoliated few layer WSe<sub>2</sub> flakes is investigated prior to and following Raman spectroscopy, specifically in the vicinity of regions probed by the Raman laser. Figures S6a–f show the corresponding topographical and phase images obtained by AFM. Regions probed by Raman laser are circled in green. The parameters associated with each probed location are listed in Table S3 according to the number assigned to each location.

Bright spots appear on all WSe<sub>2</sub> terraces in each topographical image displayed and likely reflect the roughness of the underlying SiO<sub>2</sub> as the flakes investigated are single or few layer in

thickness. In Figure S6a, the topography of the probed WSe<sub>2</sub> flake is unaffected by laser interrogation during Raman spectroscopy, whereas significant topographical and/or phase contrast is observed in the vicinity of all other probed regions in the associated AFM images (Figures S6b–f). This indicates a laser power density of 0.49 mA/ $\mu$ m<sup>2</sup>, exposure time of either 5 or 10 seconds, and accumulating 5 spectra will preserve the structural and, presumably, the chemical integrity of exfoliated WSe<sub>2</sub>. Therefore, we also assume that the same set of parameters will provide an adequate spectral resolution from WSe<sub>2</sub> buried under 5 nm Pd and 10 nm Si cap as evidenced by the Raman spectra shown in the main text. All other parameter combinations result in damaged WSe<sub>2</sub> as is evidenced by the various unusual features observed within the circled regions of Figures S6b–f after performing Raman spectroscopy. Therefore, spectra acquired from WSe<sub>2</sub> flakes after 5 nm Pd deposition, post metallization annealing, and finally a 10 nm Si cap were obtained with 0.49 mW/ $\mu$ m<sup>2</sup> power density, 5 s exposure, and 5 accumulations to avoid such spurious damage effects.



**Figure S6:** a-f) AFM topography and phase images obtained from exfoliated WSe<sub>2</sub> flakes after performing Raman spectroscopy employing a number of different parameter combinations. Each combination of parameters employed are listed according to probed location in Table S3. The green circles in each image highlight the regions probed by Raman spectroscopy. The number adjacent to each circle corresponds with the specific set of parameters employed in acquiring the associated Raman spectrum.

Image(spot)	Power Density (mW/μm²)	Exposure Time (s)	Accumulations	Damage
<b>a</b> 1	0.49	5	5	no
<b>a</b> 2	0.49	10	5	no
<b>b</b> 3	0.49	3	10	yes
<b>b</b> 4	0.49	5	10	yes
<b>b</b> 7	3.32	1	5	yes
<b>b</b> 8	3.32	2	5	yes
<b>b</b> 11	3.32	1	10	yes
<b>b</b> 12	3.32	2	10	yes
c5	0.49	10	10	yes
<b>d</b> 6	0.49	4	20	yes
e9	3.32	5	5	yes
e10	3.32	10	5	yes
<b>f</b> 13	3.32	5	10	yes
<b>f</b> 14	3.32	10	10	yes

**Table S3:** Parameters employed in performing Raman spectroscopy according to probed location in each AFM image in Figure S6.

It is also noted that employing a laser power density of  $3.32 \text{ mW}/\mu\text{m}^2$  (and presumably anything greater than this at  $\lambda$ =532 nm) imparts significant damage on WSe<sub>2</sub> within the vicinity of the probed region regardless of parameter combination employed in this work (Table S3). The Raman spectra collected from 1L WSe<sub>2</sub> employing the parameters associated with b(8) in Table S3 (blue curve) as well as a spectrum from a separate 1L WSe<sub>2</sub> flake employing 0.49 mW/ $\mu$ m<sup>2</sup>, 10 accumulations, and 1 s exposure time (black curve) are normalized according to the 2LA(M) mode and shown in Figure S7a. Both the E<sup>1</sup><sub>2g</sub>/A<sub>1g</sub> and 2LA(M) peaks obtained with parameter set 8 (blue) are redshifted by 1.5 cm<sup>-1</sup> from the spectrum which was obtained without damaging WSe<sub>2</sub> (black). The software controlling the Raman spectrometer employed in this work sums each accumulation consecutively throughout the measurement. It is therefore possible that the redshift observed here when laser power density of 3.32 mW/ $\mu$ m<sup>2</sup> is employed manifests initially as a result of Joule heating. This is consistent with a shift to lower wavenumber (higher frequency) expected of Raman active vibrational modes with increased temperature. The Joule heating induced by laser irradiation therefore provides enough energy to damage WSe<sub>2</sub> in some cases (*i.e.* Se loss and concomitant WO<sub>x</sub> formation) and even completely evaporate WSe<sub>2</sub> in the case of region 8 (Figures S8a and S8b). Despite completely evaporating WSe<sub>2</sub> directly probed by the  $3.32 \text{ mW/}\mu\text{m}^2$  laser in region 8, a Raman spectrum is still obtained. However, this is likely a result of WSe<sub>2</sub> evaporation occurring incrementally over the course of each accumulation, providing an appreciable signal to noise during the first few exposures. Therefore, even in severe cases where WSe<sub>2</sub> is completely desorbed as it appears in region 8, a Raman spectrum with reasonable signal to noise can still be obtained and other methods must be employed to test for laser induced damage.



**Figure S7.** a) Raman spectra obtained from mono layer  $WSe_2$  flakes with parameters according to b(8) in Table S3 (blue curve) and also with 0.49 mW/ $\mu$ m<sup>2</sup>, 1 s exposure, and 10 accumulations (black curve). The spectra are normalized to the 2LA(M) mode. b) Optical microscope image of an exfoliated WSe<sub>2</sub> flake on SiO<sub>2</sub> substrate showing completely evaporated WSe<sub>2</sub> in region 8 (Figure S6b) as indicated by the circular feature at the end of the green arrow exhibiting a contrast nearly identical to the substrate.



**Figure S8.** EDS spectra including the oxygen signal obtained from cross sections of Si/Pd/WSe<sub>2</sub>/SiO<sub>2</sub> structures after a) fabrication, b) 300 °C UHV anneal, and c) 300 °C forming gas anneal.

Figure S8 shows the same EDS spectra displayed in Figures 3f–h, however the oxygen signal is included here.

# 9. Constructing band diagrams from Valence Band Edge, Secondary Electron Cutoff, and WSe<sub>2</sub> core level shifts

Figure S9 shows the valence band edges and secondary electron (SE) cutoffs obtained from all exfoliated WSe<sub>2</sub> according to linear regression employing a 95% confidence interval. The significance of employing a 95% confidence interval when performing linear regression is that there is a 95% probability that the extrapolated x-intercept will fall within the associated confidence interval. The confidence intervals associated with the linear regression of the 'UHV Anneal' and 'FG Anneal' SE cutoff spectra are both  $\pm 0.01$  eV, while that of the 'UHV Anneal' and 'FG Anneal' valence band spectra are  $\pm 0.02$  eV and  $\pm 0.03$  eV, respectively. The errors displayed in Figure S9 include the  $\pm 0.05$  eV error associated with the XPS measurement.



**Figure S9:** Secondary electron cutoff and valence band edge spectra obtained from both 'exfoliated' WSe<sub>2</sub> samples prior to metal deposition. The red lines show linear fits obtained by regression.

Band diagrams were constructed from a set of common relationships between valence band edge, work function, and substrate core level binding energies as follows:

$$\phi_i = E_{Ion,WSe2} - VBM_{extrapolated}$$
 Eq. (1)

$$\Delta \phi = \phi_i - \Delta B E_{se \ 3d\frac{5}{\gamma},(WSe2)}$$
 Eq. (2)

where  $\Phi_i$  represents the initial sample work function according to the valence band offset and assumed WSe<sub>2</sub> ionization energy (E<sub>Ion,WSe2</sub>; 5.4 eV),<sup>15</sup> VBM<sub>extrapolated</sub> represents the valence band offset according to the x-axis intercept obtained from linear regression, and  $\Delta\Phi$  represents the change in work function after an experimental step according to the corresponding change in BE of bulk WSe<sub>2</sub> chemical state in the W 4*f*<sub>7/2</sub> or Se 3*d*<sub>5/2</sub> core level spectra ( $\Delta$ BE<sub>Se 3d5/2(WSe2)</sub>). Eq. (1) from the initial, exfoliated WSe<sub>2</sub> surface is corroborated with the work function value obtained from the SE cutoff. A -9.82 V bias was applied to the sample with an external power source to access the SE cutoff. Bulk WSe<sub>2</sub> chemical state shifts to lower BE correspond with a Fermi level (E<sub>F</sub>) shift towards the valence band edge. Impurities and native defects inherent to bulk TMDs cause spatial  $E_F$  variability on the order of hundreds of meV.<sup>16,17</sup> Therefore,  $E_F$  variations across exfoliated WSe<sub>2</sub> prior to metal deposition observed in this work are attributed to intrinsic  $E_F$  variation rather than surface adsorbates as the concentration of adventitious carbon is similar on all exfoliated WSe<sub>2</sub> surfaces. Nonetheless, the  $E_F$  detected from each WSe<sub>2</sub> sample at room temperature after metal deposition is within the XPS detection limit of eachother. Therefore, initial  $E_F$  variability presumably does not affect the  $E_F$  after a sufficient amount of metal is deposited.



**Figure S10.** AFM topography images and associated line profiles of WSe<sub>2</sub> flakes after exfoliation and annealing. The label at the left of each row of AFM images denotes whether the flakes were subjected to a post metallization anneal after Pd deposition and before characterization by Raman spectroscopy. The green scale bar in each image represents  $2 \mu m$ .

Topographic images were obtained ex-situ from bare WSe<sub>2</sub> flakes after exfoliating onto 270 nm SiO<sub>2</sub> substrates and annealing in N<sub>2</sub> at 300 °C for 1 hr to remove resist residue. A Veeco Model 3100 Dimension V Atomic Probe Microscope<sup>18</sup> was employed in non-contact tapping mode. Images were processed and line profiles were obtained with the WSxM software.<sup>19</sup>

AFM was employed in conjunction with Raman Spectroscopy to locate WSe<sub>2</sub> flakes with regions of one, two, and three layers. The green 'x' marked on each image in Figure S10 denotes

the region on each WSe<sub>2</sub> flake probed by Raman spectroscopy. The blue line in each image in Figure S10 denotes the cut represented by the line profile below each image.

# 11. Determining Critical Thickness of Pd on WSe<sub>2</sub> as well as Si cap on Pd for Pinhole–Free Films

Gong *et al.* employed Raman spectroscopy to investigate the effects of various metal films on characteristic first order vibrational modes of monolayer MoS<sub>2</sub>.<sup>20</sup> However, films were not deposited to full coverage thicknesses and therefore resulted in complex, difficult to interpret Raman spectra after all metal depositions. Therefore, the minimum film thickness required for pinhole free, full coverage Pd films on WSe<sub>2</sub> and Si films on full coverage Pd films were determined by He<sup>+</sup> ion–based low energy ion scattering spectroscopy (LEISS). Pd films were deposited under UHV conditions onto exfoliated highly oriented pyrolytic graphite (HOPG), a 2D material with a van der Waals surface similar to WSe<sub>2</sub>. Pd films were identified as pinhole free at a thickness preventing carbon detection by LEISS. Si was deposited under UHV conditions onto full coverage Pd–HOPG substrates also prepared under UHV conditions without breaking vacuum. A Si film was identified as pinhole free at a thickness preventing Pd detection by LEISS. Spectra were obtained *in–situ* immediately following metal or Si deposition without breaking vacuum. Figure S11 displays the LEISS spectra obtained from Pd films deposited on HOPG and Si films subsequently deposited on full coverage Pd.



Figure S11: LEISS spectra obtained from a full coverage Pd film on HOPG and full coverage Si film on Pd.

Following 5 nm deposition of Pd on HOPG, carbon is below the limit of detection by LEISS indicating full coverage films at this thickness. 10 nm Si deposited on 5 nm of Pd prevents LEISS detection of the underlying metal indicating a full coverage, pinhole free film. Surface oxidation *in–situ* of amorphous Si evaporated by electron beam under UHV conditions is reasonable as the  $\Delta G^{\circ}_{SiO2} = -428.4$  kJ/mol (per oxygen atom).<sup>21</sup> Therefore, oxygen detected after Si deposition is attributed to surface oxidation rather than either an incomplete Si film or oxygen incorporated throughout the Si film.

#### 12. Nonlinear Arrhenius Plots from Pd-WSe<sub>2</sub> Schottky Diodes

An Arrhenius plot  $(\ln(I/T^2) \text{ vs } 1/T)$  of I–V data from a Schottky diode can be employed to extract the Schottky barrier height in the forward bias region for V>>kT/q, provided the transformed data can be accurately fit by linear regression. When the Arrhenius plot yields a nonlinear temperature dependence, this indicates thermionic emission does not accurately describe the transport mechanism across the diode and other mechanisms, such as tunneling or a spatially inhomogeneous barrier height, must be considered to accurately extract the Schottky barrier height. The Arrhenius plots obtained from temperature dependent I–V measurements of Pd–WSe<sub>2</sub> Schottky diodes after fabrication and throughout post metallization annealing exhibit nonlinear characteristics (Figure S12), which indicates an alternative Schottky barrier height extraction method is needed to accurately determine the band alignment. After post metallization annealing at 400 °C in UHV, linear behavior is observed at 0.2 V forward bias and an electron Schottky barrier of 0.48 eV is extracted from the slope of the best fit line (Figure S12b). This barrier height is much smaller than the 'homogeneous' barrier height extracted using the inhomogeneous barrier height model (discussed in the main text), likely because the thermionic emission model considers a uniform barrier height. Therefore, the thermionic emission model will underestimate the barrier height in devices with an inhomogeneous barrier height.



**Figure S12.** Arrhenius plots obtained from temperature dependent I–V measurements of Pd–bulk WSe<sub>2</sub> Schottky diodes after fabrication and subsequent post metallization annealing in either a) FG or b) UHV. These plots show the nonlinear behavior in all cases but one (400 °C FG), demonstrating the need for an alternative method for accurate Schottky barrier height extraction.

# 13. Extracting Schottky Barrier Height and Unintentional Doping Density from Pd–WSe<sub>2</sub> Schottky Diodes

The barrier height can vary across the metal–semiconductor interface even in mature systems such as Si and GaN, with experimentally determined low barrier height patch densities on the order of  $10^7$  cm<sup>-2</sup>.<sup>22</sup> Low quality materials such as geological MoS<sub>2</sub> or WSe<sub>2</sub> have been reported to exhibit defect densities as high as  $3 \times 10^{12}$  cm<sup>-2</sup>, which have been shown to dominate conduction across the metal–MoS<sub>2</sub> interface.<sup>16,17</sup> The inhomogeneous Schottky barrier height model<sup>23</sup> employed in this work to fit the forward bias I–V characteristics of Pd–WSe<sub>2</sub> Schottky diodes requires the doping density of the semiconductor material. This is determined by measuring the capacitance of the same Schottky diodes in reverse bias and extracting the slope (m) of the  $1/C^2$  vs V plot, which is then inserted into Eq. 3 to solve for N<sub>D</sub>-N<sub>A</sub>,

$$m = \frac{2}{q\varepsilon_S\varepsilon_0(N_D - N_A)}$$
Eq. (3)

where q is the charge of an electron,  $\epsilon_S$  is the WSe<sub>2</sub> dielectric constant (7.2),<sup>24</sup>  $\epsilon_0$  is the vacuum permittivity and N<sub>D</sub>-N<sub>A</sub> is the unintentional doping density of the WSe<sub>2</sub>.



**Figure S13.**  $1/C^2$  vs V plots and fitted lines measured from a) a Pd–WSe<sub>2</sub> Schottky diode demonstrating a frequency independent slope and b) from many Pd–WSe<sub>2</sub> Schottky diodes prior to subsequent anneals in UHV or FG (measured at 1 MHz), which demonstrate a spatially varying WSe<sub>2</sub> doping density across a single WSe<sub>2</sub> crystal and from crystal to crystal.

This method requires the data plotted as  $1/C^2$  vs V to exhibit slope and intercept independent of frequency,<sup>25</sup> which is demonstrated in Figure S13a for three different Schottky diodes. The WSe<sub>2</sub> doping density varies spatially from  $1.00 \times 10^{17}$  cm<sup>-3</sup> to  $2.02 \times 10^{17}$  cm<sup>-3</sup>, as expected according to previous work,<sup>16,17</sup> according to the range of slopes fitted in the  $1/C^2$  vs V plot for a number of diodes and two different synthetic WSe<sub>2</sub> crystals (Figures S13b).

#### 14. Analytic Schottky Barrier Model using Landauer Transport Theory

Figure S14 shows the measured  $I_{DS}-V_{BG}$  transfer characteristics (solid lines) of two back gated WSe<sub>2</sub> FETs with Pd contacts after fabrication and throughout post metallization annealing in either UHV or FG. The fits of the subthreshold regions of the  $I_{DS}-V_{BG}$  curves are performed independently on each carrier branch from the point of minimum current and are also shown in Figure S14 (symbols). In–plane carrier effective masses  $m_e^*=0.33m_0$  and  $m_h^*=0.46m_0$  are employed in the model.<sup>26</sup> The transfer characteristics of the device after 300 °C FG anneal are omitted because of a measurement error. Nonetheless, the devices annealed in FG underwent consecutive anneals at 200 °C, 300 °C, and 400 °C and therefore the 400 °C FG anneal  $I_{DS}-V_{BG}$ transfer characteristics can be directly compared to those obtained from a separate device after 400 °C UHV anneal.



**Figure S14.** Measured  $I_{DS}$ - $V_{BG}$  transfer curves from Pd-WSe<sub>2</sub> back gated FETs after fabrication and subsequent post metallization annealing in either UHV or FG.

#### 15. Transfer Characteristics of Back Gated WSe<sub>2</sub> Transistors

Two sets of three back gated WSe<sub>2</sub> transistors with Pd contacts were fabricated for the study. One set was subjected to the UHV anneals and another set was subjected to the FG anneals. The corresponding transfer characteristics are shown below. Some device to device variability is measured, but this is common in TMD-based devices. The anneals reduce the device to device variability and the overall trends in Fermi level shift follows the trends reflected in Figure 6 according to device transfer characteristics.



**Figure S15:** Measured  $I_{DS}-V_{BG}$  transfer curves from three devices annealed in a) ultra-high vacuum and b) forming gas, separately, showing agreement in the general trend and some expected device to device variability.

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